



## P\_K\_.1206.2ST.\_

# Platinum thin film RTD

### For the automatic assembling on PCBs





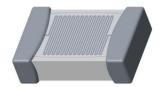




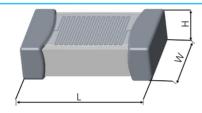
#### Benefits & Characteristics

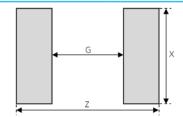
#### Product image

- Excellent long-term stability and resistance to thermal cycling
- Low self-heating
- Automatic assembly in large-volume applications



#### Illustration<sup>1)</sup>





#### **Dimensions**

Dimensions in mm	L	W	н
	$3.1 \pm 0.15$	1.6 ± 0.15	$0.5 \pm 0.1$
Land pattern in mm	Z	G	X
	4.00	1.90	1.75

#### Technical Data

#### **Electrical Specifications**

Operating temperature range	-50 °C to +150 °C (see general	notes 1.1)
Nominal resistance	100 $\Omega$ at 0 °C, 500 $\Omega$ at 0 °C,	1000 Ω at 0 °C
Characteristic	IEC 60751	
Tolerance class (dependent on temperature range)		IST AG reference
	IEC 60751 F0.15	А
	IEC 60751 F0.3	В
	IEC 60751 F0.6	C
Temperature coefficient	3850 ppm/K	
Temperature dependence of resistivity	according to IEC 60751:	
	-50 °C to 0 °C R(T) = $R_0$ x (1+AxT + BxT² + Cx[T-100] x 0 to +150 °C R(T) = $R_0$ x (1+AxT + BxT²)	

A =  $3.9083 \times 10^{-3} \times ^{\circ}\text{C}^{-1}$ , B=  $-5.775 \times 10^{-7} \times ^{\circ}\text{C}^{-2}$ C =  $-4.183 \times 10^{-12} \times ^{\circ}\text{C}^{-4}$ 

 $R_0$  = resistance value in  $\Omega$  at 0°C T = temperature in accordance with ITS90

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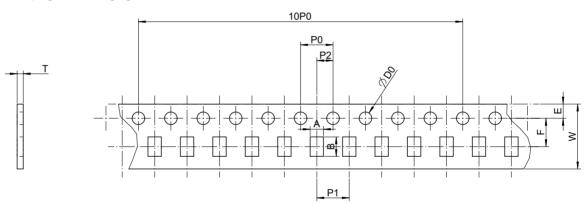


#### **General Specifications**

deficial specifications			
Pads (soldering connection)	Soft-Termination galvanic tin plated with nickel barrier layer		
Soldering (according to J-STD-002E) see general notes 1.3	<ol> <li>Solderability: Test A and A1</li> <li>Resistance to soldering heat: Test A and A1</li> </ol>		
Measuring current	Pt 100	Pt 500	Pt 1000
(Self-heating has to be considered)	1 mA	0.5 mA	0.3 mA
Long-term stability:	< 0.04 % at 1000 h	at 130 °C	
Taping & Packaging (according to IEC 60286-3)	EIA-481 (for dimensions see general notes 1.2)		
Storage Property	12 months (original packaging and dry conditions)		
REACH + RoHs Compliance	Yes		
Special	Use in dry environm	ent only	

#### **General Notes**

- 1.1 The thermal coefficient of expansion of the circuit board has to be considered.
- 1.2 Taping and Packaging:



Item	A	В	w	E	F	P0	P1	P2	D0	T	10P0
Dimension	1.9	3.5	8.0	1.75	3.5	4.0	4.0	2.0	1.5	0.6	40.0
min. Tol.	-0.1	-0.1	-0.3	-0.1	-0.05	-0.1	-0.1	-0.05	-0.0	-0.1	-0.2
max. Tol.	+0.1	+0.1	+0.3	+0.1	+0.05	+0.1	+0.1	+0.05	+0.1	+0.1	+0.2

#### Dimensions in mm

Packaging unit in tape and reel, special variants, small quantities or other packaging unit are available on request.

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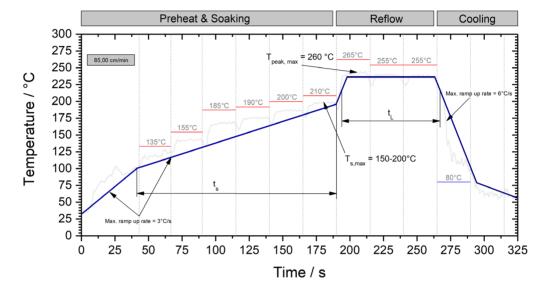


#### 1.3 Soldering and Reflow soldering profile:

For soldering IST AG recommends lead free solder paste (Material: SnAgCu 96.5/3.0/0.5) and a temperature characteristic (reflow profile) for reflow accoring to JEDEC J-STD-002E. The solderability was tested with following assembly conditions:

PCB Material FR4 (PCB Layer: 2) PCB thickness: 1.6 mm Dimensions: 72 x 32 mm

Solder Paste: KOKI «S3X58-M406» (Pb-free assembly)



Profile parameter	Temperature range / °C	Heating rate / °C/s	Time / s
Ramp to Preheat	RT to 150	1.9 - 3	
Preheat / Soak	$T_{s,min} = 100, T_{s,max} = 200$	1.9 - 3	$t_{s,min} = 60, t_{s,max} = 160$
Ramp to Peak	180 - 255	0.6	
Reflow	$250 \pm 5$ , $T_{peak, max} = 260$		60 to 120, $t_{peak,max} = 30$
Cooling	255 - RT	1.6 - 3	

<sup>\*</sup>Temperature is measured on topside of PCB.

#### 1.4 Important Notes:

- The solder or additional fluxes should be halogen-free, mild and non-activated.
- After soldering, a thorough cleaning with pH-neutral defluxing material is recommended.
- The profile has a significant impact on the solder joint performance, i.e. solderability, wettability and strength.
- The soak profile and all other data serve as a guideline and cannot be regarded as binding statements or guaranteed values. They serve as a starting point for process development. Specifically, a high mix of components or large board sizes might require the development of a different soldering profile.
- Long-term stability in the application and chemical resistance need to be approved by the customer.
- The customer is obliged to test and approve the suitability of IST AG sensors in the customer's application.

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### Order Information

Description	Tolerance class	Packaging type	Order number			
Other tolerances, values of resistance are available on request						
Nominal resistance: 100 Ω at 0 °C			455555			
P0K1.1206.2ST.A	IEC 60751 F0.15 (A)	packed in bags	153288			
P0K1.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side up)	153303			
P0K1.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side down)	153481			
POK1.1206.2ST.B	IEC 60751 F0.3 (B)	packed in bags	153289			
P0K1.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side up)	153304			
POK1.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side down)	153482			
P0K1.1206.2ST.C	IEC 60751 F0.6 (C)	packed in bags	153290			
P0K1.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side up)	153305			
P0K1.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side down)	153483			
Nominal resistance: 500 $\Omega$ at 0 $^{\circ}\text{C}$						
P0K5.1206.2ST.A	IEC 60751 F0.15 (A)	packed in bags	153296			
P0K5.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side up)	153476			
P0K5.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side down)	153495			
P0K5.1206.2ST.B	IEC 60751 F0.3 (B)	packed in bags	153297			
P0K5.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side up)	153477			
P0K5.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side down)	153496			
P0K5.1206.2ST.C	IEC 60751 F0.6 (C)	packed in bags	153301			
P0K5.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side up)	153478			
P0K5.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side down)	153498			
Nominal resistance: 1000 $\Omega$ at 0 °C						
P1K0.1206.2ST.A	IEC 60751 F0.15 (A)	packed in bags	153291			
P1K0.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side up)	153470			
P1K0.1206.2ST.A.S	IEC 60751 F0.15 (A)	taped on reel (sensor side down)	153484			
P1K0.1206.2ST.B	IEC 60751 F0.3 (B)	packed in bags	153293			
P1K0.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side up)	153472			
P1K0.1206.2ST.B.S	IEC 60751 F0.3 (B)	taped on reel (sensor side down)	153485			
P1K0.1206.2ST.C	IEC 60751 F0.6 (C)	packed in bags	153294			
P1K0.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side up)	153473			
P1K0.1206.2ST.C.S	IEC 60751 F0.6 (C)	taped on reel (sensor side down)	153486			



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